GBP2005 THRU GBP210

Glass Passivated Bridge Rectifiers

Glass passivated chip

Features

- Low forward voltage drop
- Ideal for printed circuit board
- •Meet UL flammability classification 94V-0

Mechanical Data

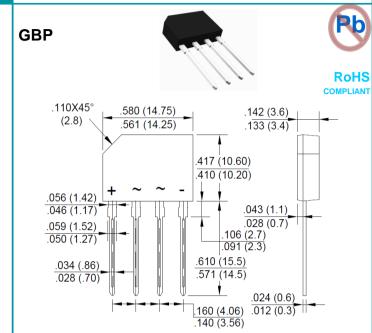
- Polarity: Symbol marked on body
- Mounting position: Any

Note: Products with logo or or are made by HY Electronic (Cayman) Limited.

Applications

 General purpose use in AC/DC bridge full wave rectification, for home appliances, office equipment, etc.

Reverse Voltage - 50 to 1000 Volts Forward Current - 2.0 Amperes



Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

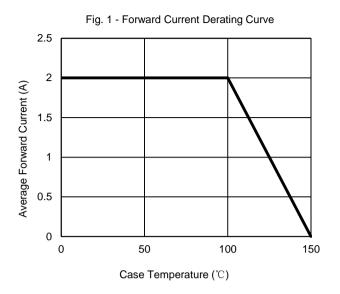
For capacitive load, derate current by 20%.

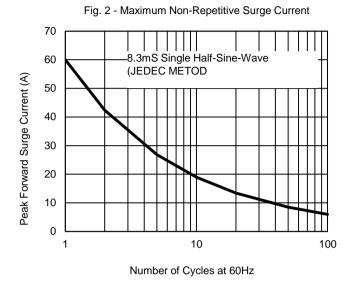
Characteristics	Symbol	GBP	GBP	GBP	GBP	GBP	GBP	GBP	Unit
	Symbol	2005	201	202	204	206	208	210	
Maximum Repetitive Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Tc=100 ℃	I(AV)	2.0							Α
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,	Ison	IFSM 60							Λ
Superimposed on Rated Load (JEDEC Method)	IFSIVI	00							Α
Peak Forward Surge Current, 1mS Single Half Sine-Wave,	IFSM	120							Α
Superimposed on Rated Load (JEDEC Method)	IFSIVI				120				^
I ² t Rating for Fusing(1ms≤t≤8.3ms)	l ² t	14.9						A ² s	
Peak Forward Voltage per Diode at 2.0A DC	VF	1.05						V	
Maximum DC Reverse Current at Rated @TJ=25°C	lr	5							μА
DC Blocking Voltage per Diode @TJ=125°C	IK	500							
Typical Thermal Resistance to Ambient (without heatsink)	Reja	40							℃/W
Typical Thermal Resistance to case (with heatsink)	Rejc	10							℃/W
Typical Thermal Resistance to lead (without heatsink)	Røjl	5							°C/W
Operating Junction Temperature Range	TJ	-55 to +150							$^{\circ}$
Storage Temperature Range	Тsтg	-55 to +150							$^{\circ}$

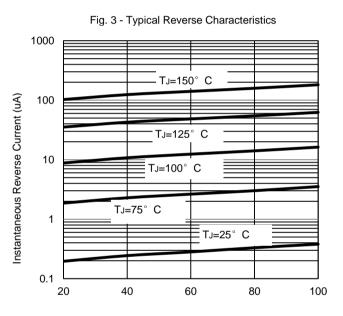
Note: The typical data above is for reference only

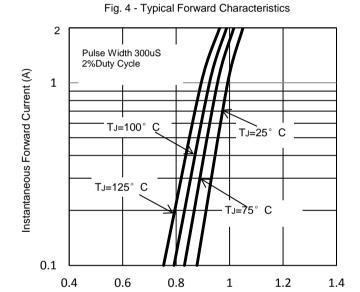
Rating and Characteristic Curves GBP2005 THRU GBP210













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